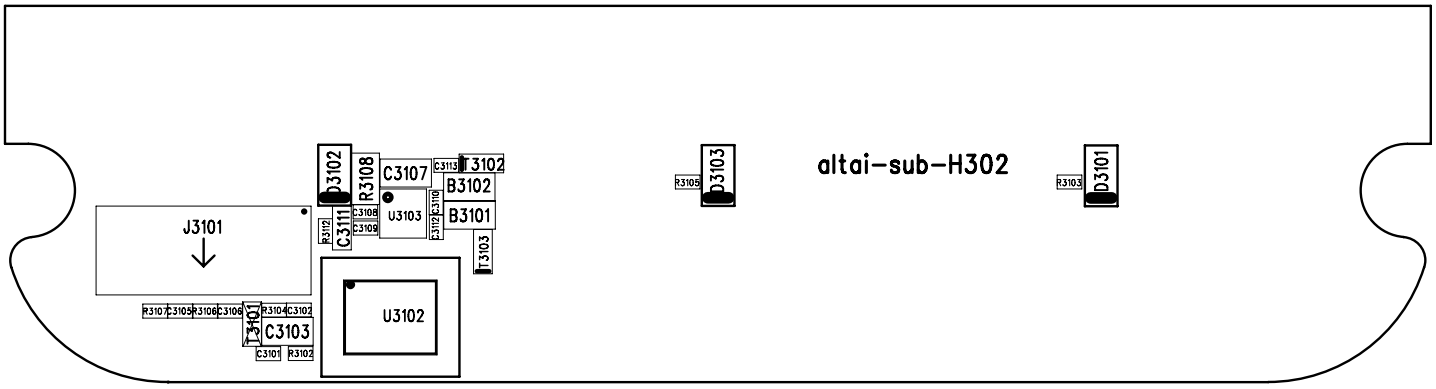
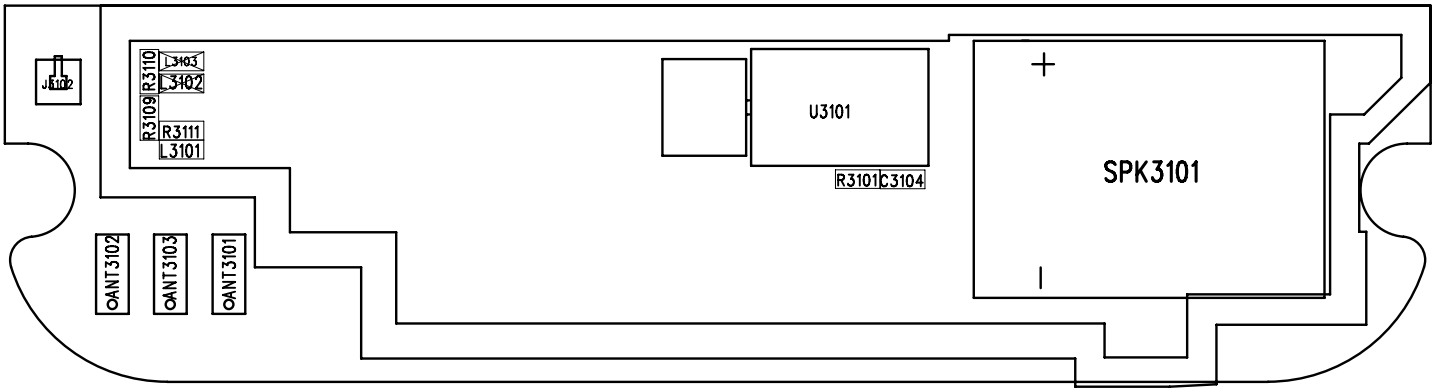
lenovo mobile	TEL:86-0592-2166608 FAX:			Eng: chenyc
Project Name: altai-sub-H302				layers: 4
layer: Si01		material: FR4		thickness: 0.4+/-0.1mm
via type	through via	blind via	buried via	w/d: 4/4 3/3
	v1-4			20130118



altai_sub_h302.pcb - Mon Jan 21 09:54:55 2013

lenovo mobile	TEL:86-0592-2166608 FAX:			Eng: chenyc
Project Name: altai-sub-H302				layers: 4
layer: L4		material: FR4		thickness: 0.4+\-0.1mm
via type	through via	blind via	buried via	w\d: 4\4 3\3
	v1-4			20130118



altai_sub_h302.pcb - Mon Jan 21 09:55:13 2013